

STTH120R04TV

Ultrafast recovery diode

Main product characteristics

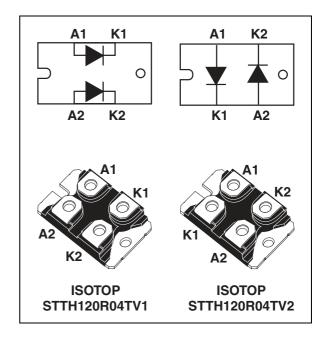
| I _{F(AV)} | 2 x 60 A |
|-----------------------|----------|
| V _{RRM} | 400 V |
| Tj | 150° C |
| V _{F (typ)} | 0.95 V |
| t _{rr (typ)} | 31 ns |

Features and benefits

- Ultrafast
- Very low switching losses
- High frequency and high pulsed current operation
- Low leakage current
- Insulated package:
 - ISOTOP
 Electrical insulation = 2500 V_{RMS}
 Capacitance = 45 pF

Description

The STTH120R04TV series uses ST's new 400 V planar Pt doping technology. The STTH120R04 is specially suited for switching mode base drive and transistor circuits, such as welding equipment.



Order codes

| Part Number | Marking |
|---------------|---------------|
| STTH120R04TV1 | STTH120R04TV1 |
| STTH120R04TV2 | STTH120R04TV2 |

Characteristics STTH120R04TV

1 Characteristics

Table 1. Absolute ratings (limiting values per diode at 25° C, unless otherwise specified)

| Symbol | Parameter | | | Value | Unit |
|---------------------|--|-------------|------------------------|--------------|------|
| V _{RRM} | Repetitive peak reverse voltage | | | 400 | ٧ |
| V _{RSM} | Non repetitive peak reverse voltage | | | 400 | ٧ |
| I _{F(RMS)} | RMS forward current | Per diode | | 140 | Α |
| | Average forward current, $\delta = 0.5$ | Per diode | T _c = 75° C | 60 | Α |
| I _{F(AV)} | Average lorward current, $\delta = 0.5$ | Per package | T _c = 70° C | 120 | Α |
| I _{FRM} | Repetitive peak forward current $t_p = 5 \mu s$, $F = 1 kHz square$ | | 1800 | Α | |
| I _{FSM} | Surge non repetitive forward current t _p = 10 ms Sinusoidal | | | 700 | Α |
| T _{stg} | Storage temperature range | | | -65 to + 150 | °C |
| T _j | Maximum operating junction temperature | | | 150 | ç |

Table 2. Thermal parameters

| Symbol | Parameter | | Value | Unit |
|--------------------|-----------------------------|-----------|-------|------|
| D | Junction to case | Per diode | 0.8 | |
| $R_{th(j-c)}$ | Total | 0.45 | ° C/W | |
| R _{th(c)} | Coupling thermal resistance | | 0.1 | |

When the diodes are used simultaneously: $\Delta T_{j(diode1)} = P_{(diode1)} \ x \ R_{th(j\text{-}c)} \ (\text{per diode}) + P_{(diode2)} \ x \ R_{th(c)}$

Table 3. Static electrical characteristics

| Symbol | Parameter | Test conditions | | Min. | Тур | Max. | Unit |
|---|-------------------------|-------------------------|-----------------------|------|------|------|------|
| I _B ⁽¹⁾ | Povorce leekage aurrent | T _j = 25° C | V - V | | | 60 | |
| I _R ⁽¹⁾ Reverse leakage current | T _j = 125° C | $V_R = V_{RRM}$ | | 60 | 600 | μA | |
| | | T _j = 25° C | | | | 1.5 | |
| V _F ⁽²⁾ | Forward voltage drop | T _j = 100° C | I _F = 60 A | | 1.05 | 1.3 | V |
| | | T _j = 150° C | | | 0.95 | 1.2 | |

^{1.} Pulse test: $t_p = 5$ ms, $\delta < 2$ %

To evaluate the conduction losses use the following equation:

$$P = 0.9 \times I_{F(AV)} + 0.005 \times I_{F}^{2}(RMS)$$

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^{2.} Pulse test: $t_{\rm p}$ = 380 μ s, δ < 2 %

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Table 4. Dynamic characteristics

| Symbol | Parameter | Test conditions | Min. | Тур | Max. | Unit |
|-----------------|--|---|------|-----|------|------|
| | | $I_F = 1 \text{ A, } dI_F/dt = -50 \text{ A/}\mu\text{s,}$ $V_R = 30 \text{ V, } T_j = 25^{\circ} \text{ C}$ | | | 80 | |
| t _{rr} | Reverse recovery time | $I_F = 1 \text{ A, } dI_F/dt = -100 \text{ A/}\mu\text{s,}$ $V_R = 30 \text{ V, } T_j = 25^{\circ} \text{ C}$ | | 40 | 55 | ns |
| | $I_F = 1 \text{ A, } dI_F/dt = -200 \text{ A/}\mu\text{s,}$ $V_R = 30 \text{ V, } T_j = 25^{\circ} \text{ C}$ | | 31 | 45 | | |
| I _{RM} | Reverse recovery current | $I_F = 60 \text{ A}, dI_F/dt = -200 \text{ A/}\mu\text{s}, \ V_R = 320 \text{ V}, T_j = 125^{\circ} \text{ C}$ | | 11 | 16 | Α |
| S | Softness factor | $I_F = 60 \text{ A}, dI_F/dt = -200 \text{ A/}\mu\text{s}, \ V_R = 320 \text{ V}, T_j = 125^{\circ} \text{ C}$ | | 0.4 | | |
| t _{fr} | Forward recovery time | $I_F = 60 \text{ A}$ $dI_F/dt = 100 \text{ A/µs}$ $V_{FR} = 1.5 \text{ x } V_{Fmax}, T_j = 25^{\circ} \text{ C}$ | | 600 | | ns |
| V _{FP} | Forward recovery voltage | $I_F = 60 \text{ A}, \text{ d}I_F/\text{d}t = 100 \text{ A}/\mu\text{s},$ $T_j = 25^{\circ} \text{ C}$ | | 3.2 | | V |

Figure 1. Conduction losses versus average current

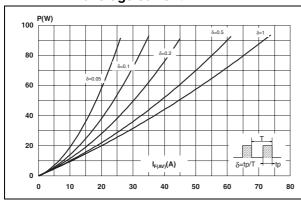


Figure 2. Forward voltage drop versus forward current

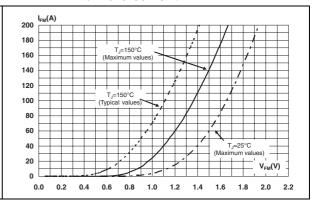


Figure 3. Relative variation of thermal impedance junction to case versus pulse duration

tp(s)

1.E-01

1.E+00

1.E-02

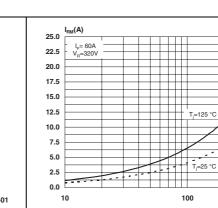


Figure 4. Peak reverse recovery current versus dl_F/dt (typical values)

0.1

1.0

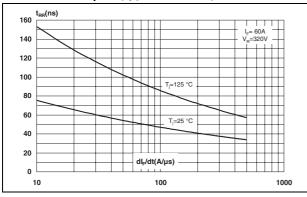
1000

dl_F/dt(A/μs)

Characteristics STTH120R04TV

Figure 5. Reverse recovery time versus dl_F/dt (typical values)

Figure 6. Reverse recovery charges versus dl_F/dt (typical values)



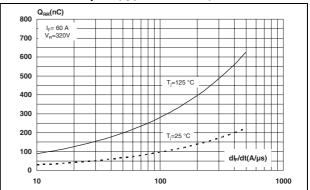
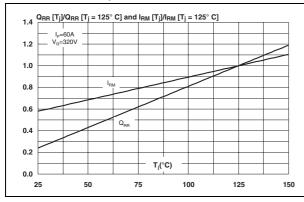


Figure 7. Relative variations of dynamic parameters versus junction temperature

Figure 8. Transient peak forward voltage versus dl_F/dt (typical values)



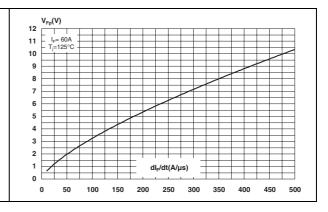
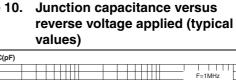
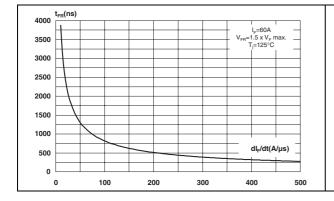
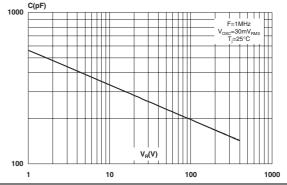


Figure 9. Forward recovery time versus dl_F/dt Figure 10. Junction cap (typical values)







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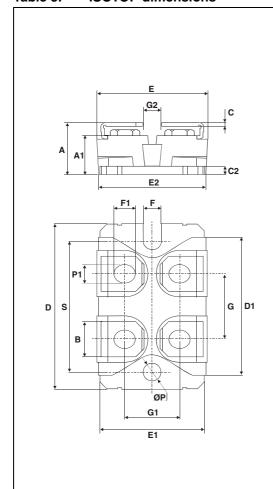
STTH120R04TV Package information

2 Package information

Epoxy meets UL94, V0

Cooling method: by conduction (C)

Table 5. ISOTOP dimensions



| | Dimensions | | | | |
|------|------------|--------|-------|--------|--|
| Ref. | Millim | neters | Inc | nes | |
| | Min. | Max. | Min. | Max. | |
| Α | 11.80 | 12.20 | 0.465 | 0.480 | |
| A1 | 8.90 | 9.10 | 0.350 | 0.358 | |
| В | 7.8 | 8.20 | 0.307 | 0.323 | |
| С | 0.75 | 0.85 | 0.030 | 0.033 | |
| C2 | 1.95 | 2.05 | 0.077 | 0.081 | |
| D | 37.80 | 38.20 | 1.488 | 1.504 | |
| D1 | 31.50 | 31.70 | 1.240 | 1.248 | |
| Е | 25.15 | 25.50 | 0.990 | 1.004 | |
| E1 | 23.85 | 24.15 | 0.939 | 0.951 | |
| E2 | 24.80 typ. | | 0.97 | 6 typ. | |
| G | 14.90 | 15.10 | 0.587 | 0.594 | |
| G1 | 12.60 | 12.80 | 0.496 | 0.504 | |
| G2 | 3.50 | 4.30 | 0.138 | 0.169 | |
| F | 4.10 | 4.30 | 0.161 | 0.169 | |
| F1 | 4.60 | 5.00 | 0.181 | 0.197 | |
| Р | 4.00 | 4.30 | 0.157 | 0.69 | |
| P1 | 4.00 | 4.40 | 0.157 | 0.173 | |
| S | 30.10 | 30.30 | 1.185 | 1.193 | |

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

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Ordering information STTH120R04TV

3 Ordering information

| Part Number | Marking | Package | Weight | Base qty | Delivery mode |
|---------------|---------------|---------|--------|----------|---------------|
| STTH120R04TV1 | STTH120R04TV1 | ISOTOP | 27 g | 10 | Tube |
| STTH120R04TV2 | STTH120R04TV2 | ISOTOP | 27 g | 10 | Tube |

4 Revision history

| Date | Revision | Description of Changes |
|-------------|----------|------------------------|
| 31-Mar-2007 | 1 | First issue |

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